### **SM-8 BIPOLAR TRANSISTOR H-BRIDGE**

**ZHB6790** 

### PRELIMINARY DATA SHEET ISSUE B JULY 1997

### **FEATURES**

- \* Compact package
- \* Low on state losses
- \* Low drive requirements
- \* Operates up to 40V supply
- \* 2 Amp continuous rating



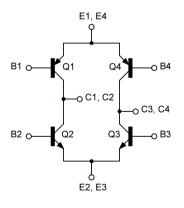


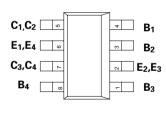
### ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	NPNs	PNPs	UNIT
Collector-Base Voltage	V <sub>CBO</sub>	50	-50	V
Collector-Emitter Voltage	V <sub>CEO</sub>	40	-40	V
Emitter-Base Voltage	V <sub>EBO</sub>	5	-5	٧
Peak Pulse Current	I <sub>CM</sub>	6	-6	Α
Continuous Collector Current	I <sub>C</sub>	2	-2	Α
Operating and Storage Temperature Range	T <sub>j</sub> :T <sub>stg</sub>	-55 to +150		°C

### **SCHEMATIC DIAGRAM**

### **CONNECTION DIAGRAM**

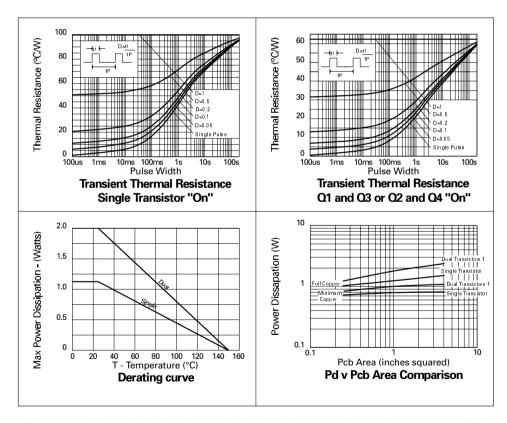






### THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	VALUE	UNIT
Total Power Dissipation at T <sub>amb</sub> = 25°C* Any single transistor "on" Q1 and Q3 "on" or Q2 and Q4 "on" equally	P <sub>tot</sub>	1.25 2	W W
Derate above 25°C* Any single transistor "on" Q1 and Q3 "on" or Q2 and Q4 "on" equally		10 16	mW/ °C mW/ °C
Thermal Resistance - Junction to Ambient* Any single transistor "on" Q1 and Q3 "on" or Q2 and Q4 "on" equally		100 62.5	°C/W °C/W



<sup>\*</sup> The power which can be dissipated assuming the device is mounted in a typical manner on a PCB with copper equal to 2 inches square.

†"Two devices on" is the standard operating condition for the bridge. Eg. opposing NPN/PNP pairs rurned on.

# PNP TRANSISTORS ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25$ °C).

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PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-50			V	I <sub>C</sub> =-100μA
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	-40			V	I <sub>C</sub> =-10mA*
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-5			V	I <sub>E</sub> =-100μA
Collector Cutoff Current	I <sub>CBO</sub>			-0.1	μА	V <sub>CB</sub> =-30V
Emitter Cutoff Current	I <sub>EBO</sub>			-0.1	μА	V <sub>EB</sub> =-4V
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>			-0.14 -0.25 -0.45 -0.75	V V V	I <sub>C</sub> =-100mA, I <sub>B</sub> =-0.5mA* I <sub>C</sub> =-500mA, I <sub>B</sub> =-5mA* I <sub>C</sub> =-1A, I <sub>B</sub> =-10mA* I <sub>C</sub> =-2A, I <sub>B</sub> =-50mA*
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>			-1.0	V	I <sub>C</sub> =-1A, I <sub>B</sub> =-10mA*
Base-Emitter Turn-On Voltage	V <sub>BE(on)</sub>		-0.75		V	I <sub>C</sub> =-1A, V <sub>CE</sub> =-2V*
Static Forward Current Transfer Ratio	h <sub>FE</sub>	300 200 150				I <sub>C</sub> =-100mA, V <sub>CE</sub> =-2V I <sub>C</sub> =-1A, V <sub>CE</sub> =-2V* I <sub>C</sub> =-2A, V <sub>CE</sub> =-2V*
Transition Frequency	$f_{T}$	100			MHz	I <sub>C</sub> =-50mA, V <sub>CE</sub> =-5V f=50MHz
Input Capacitance	C <sub>ibo</sub>		225		pF	V <sub>EB</sub> =-0.5V, f=1MHz
Output Capacitance	C <sub>obo</sub>		24		pF	V <sub>CB</sub> =-10V, f=1MHz
Switching Times	t <sub>on</sub> t <sub>off</sub>		35 600		ns	I <sub>C</sub> =-500mA, I <sub>B1</sub> = -50mA I <sub>B2</sub> =-50mA, V <sub>CC</sub> =-10V

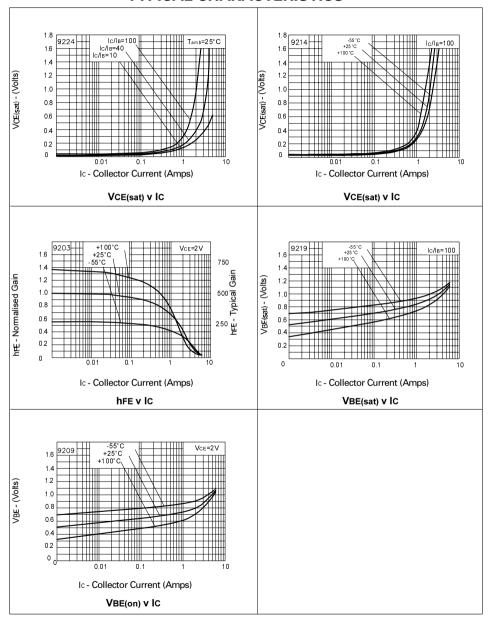
<sup>\*</sup>Measured under pulsed conditions. Pulse width=300µs. Duty cycle ≤ 2%.

# NPN TRANSISTORS ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25$ °C).

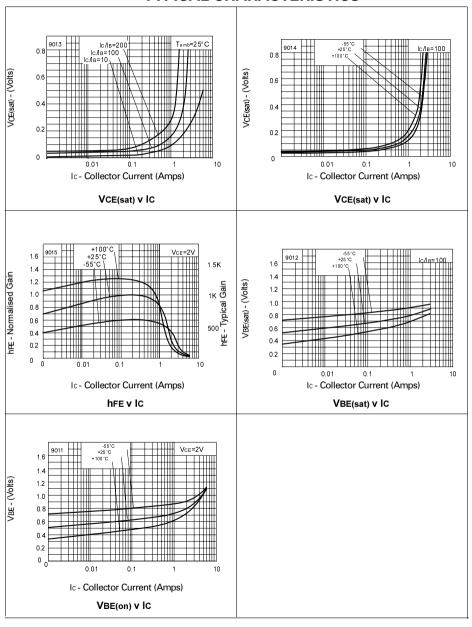
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.	
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	50			V	I <sub>C</sub> =100μA	
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	40			V	I <sub>C</sub> =10mA*	
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	5			V	I <sub>E</sub> =100μA	
Collector Cutoff Current	I <sub>CBO</sub>			0.1	μА	V <sub>CB</sub> =35V	
Emitter Cutoff Current	I <sub>EBO</sub>			0.1	μА	V <sub>EB</sub> =4V	
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>			0.1 0.16 0.5 0.35	V V V	I <sub>C</sub> =100mA, I <sub>B</sub> =0.5mA* I <sub>C</sub> =500mA, I <sub>B</sub> =2.5mA* I <sub>C</sub> =1A, I <sub>B</sub> =5mA* I <sub>C</sub> =2A, I <sub>B</sub> =30mA*	
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>			0.9	V	I <sub>C</sub> =1A, I <sub>B</sub> =10mA*	
Base-Emitter Turn-On Voltage	V <sub>BE(on)</sub>		0.73		V	I <sub>C</sub> =1A, V <sub>CE</sub> =2V*	
Static Forward Current Transfer Ratio	h <sub>FE</sub>	500 400 150				I <sub>C</sub> =100mA, V <sub>CE</sub> =2V* I <sub>C</sub> =1A, V <sub>CE</sub> =2V* I <sub>C</sub> =2A, V <sub>CE</sub> =2V*	
Transition Frequency	f <sub>T</sub>	150			MHz	I <sub>C</sub> =50mA, V <sub>CE</sub> =5V f=50MHz	
Input Capacitance	C <sub>ibo</sub>		200		pF	V <sub>EB</sub> =0.5V, f=1MHz	
Output Capacitance	C <sub>obo</sub>		16		pF	V <sub>CB</sub> =10V, f=1MHz	
Switching Times	t <sub>on</sub> t <sub>off</sub>		33 1300		ns	I <sub>C</sub> =500mA, I <sub>B!</sub> =50mA I <sub>B2</sub> =50mA, V <sub>CC</sub> =10V	

<sup>\*</sup>Measured under pulsed conditions. Pulse width=300µs. Duty cycle ≤ 2%.

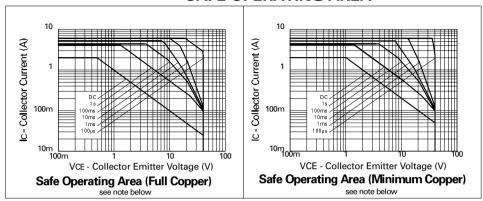
# PNP TRANSISTOR TYPICAL CHARACTERISTICS



# NPN TRANSISTOR TYPICAL CHARACTERISTICS



### SAFE OPERATING AREA



Note: The Safe Operating Area (SOA) charts shown are a combination of the worst case secondary breakdown characteristics for the NPN/PNP pair, and the thermal curves demonstrating the power dissipation capability of the energised ZHB part (opposing NPN-PNP switched on) when mounted on a 50mm x 50mm FR4 PCB. The two cases show:

i) full copper present and

ii) with minimal copper present - this being defined as an SM-8 footprint with 1.5mm tracks to the edge of the PCB.

For example, on a 50mm x 50mm full copper PCB, the ZHB6790 will safely dissipate 2W under DC conditions, taking note of continuous current ratings and voltage limits. Higher powers can be tolerated for pulsed operation, while the shorter pulse widths (100µs and 1ms) being relevant for assessment of switching conditions.

The ZHB6790 'H'-Bridge can be modelled within SPICE using the following transistor models configured in the standard 'H'-Bridge topology, as shown in the schematic diagram of this datasheet.

ZETEX H Bridge NPN transistors Spice model Last revision 4/7/97

- .MODEL H6790N NPN IS =2.505E-12 NF =1.0058 BF =1360 IKF=1.3 VAF=35
- +ISE=.24E-12 NE =1.38 NR =1.001 BR =125 IKR=1 VAR=8 ISC=.435E-12
- +NC =1.213 RB =.2 RE =.043 RC =.04 CJC=54.3E-12 MJC=.475 VJC=.765
- +CJE=247E-12 TF =.851E-9 TR =15.7E-9

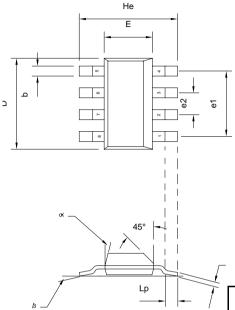
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- \*ZETEX H Bridge PNP transistors Spice model Last revision 4/7/97
- .MODEL H6790P PNP IS=1.09684E-12 NF=1.0102 BF=650 IKF=1.7 VAF=23.5
- +ISE=9.88593E-14 NE=1.47256 NR=1.00391 BR=270 IKR=0.2 VAR=30
- +ISC=5.4933E-14 NC=1.07427 RB=0.055 RE=0.049 RC=0.078 CJC=96E-12
- +MJC=0.495 VJC=0.67 CJE=275E-12 TF=0.75E-9 TR=10.8E-9

\*

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Dim	Millimetres			Inches		
	Min	Тур	Max	Min	Тур	Max
Α	-	-	1.7	_	-	0.067
A1	0.02	1	0.1	0.0008	1	0.004
b	-	0.7	-	_	0.028	-
С	0.24	-	0.32	0.009	_	0.013
D	6.3	-	6.7	0.248	_	0.264
Е	3.3	-	3.7	0.130	_	0.145
e1	-	4.59	_	_	0.180	_
e2	-	1.53	1	-	0.060	1
He	6.7	_	7.3	0.264	-	0.287
Lp	0.9	-	-	0.035	-	-



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